Tool ID: 618 Tool Location: 128

### **Equipment Information Sheet**

# **AFM - Veeco Icon**

Backup: John Treichler 607-254-4949

Backup: Xinwei Wu 607-254-4934

Manager: Roberto Panepucci 607-254-4855 Calls to staff phones will be automatically forwarded to their cell phones during accessible hours. At other times

Minimum Tool Time: 15 minutes

leave a message or send them an email.

### **SAFETY**

• No unusual hazards during normal operation

## **USAGE RESTRICTIONS SCHEDULING/SIGN-UP RESTRICTIONS**

• Maximum 2 hour block anytime

### MATERIALS COMPATIBILITY CATEGORY

| Tool Category 5: Class A and B Metals and Compounds   |   |
|---|---|
| Allowed   | Not Allowed                                     |
| Tool category 1/1E, 2, 3, and 4 materials             |   |
| Silicon Based Substrates and Films                    |   |
| III/V compound Semiconductors                         |   |
| Glass Substrates                                      |   |
| PECVD and ALD Films                                   |   |
| Cured organics and baked Photoresist                  |   |
| CNF Class A, B, and Refractory metals                 |   |
| Exposed Gold, Silver, Copper                          |   |
| Alkali and Alkaline Compounds                         |   |
| Organic/Biology Molecules prepared-<br>w/salt buffers |   |
| High Vapor Pressure Materials (Mg, Ca,                | * Some tool restrictions on high vapor pressure |
| Zn)*  | materials may apply                             |
| Soft organic materials                                |   |

High Vapor Pressure Metals and Compounds are materials that have a vapor pressure above 1e-6 Torr at 400 C.

# **Additional Material Restrictions and Exceptions**

- 6 wafers or smaller
- Magnetic pucks available for small pieces

Last Updated: 04/04/2025